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## **OSW4XAHAE1E**

VER.1

### **Features**

- High-power LED
- Long lifetime operation
- Typical viewing angle: 140deg
- RoHS compliant
- Possible to attach to heat sink directly without using print circuit board.

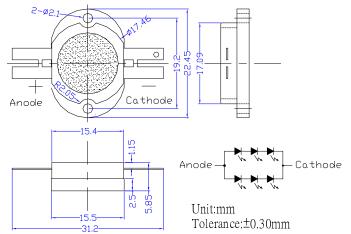
### **Applications**

- Indoor & outdoor lighting
- Stage lighting
- Reading lamps
- Display cases, furniture illumination, marker
- Architectural illumination
- **Spotlights**

### **■Outline Dimension**

(Ta=25℃)

(Ta=25°C)



Tolerances are for reference only

## ■Absolute Maximum Rating

Item	Symbol	Value	Unit
DC Forward Current *1	$I_{\mathrm{F}}$	1,400	mA
Pulse Forward Current*2	$I_{FP}$	2,000	mA
Reverse Voltage	$V_R$	15	V
Power Dissipation*1	$P_{D}$	15,960	mW
Operating Temperature	Topr	-30 ~ +85	$^{\circ}\!\mathbb{C}$
Storage Temperature	Tstg	-40~ +100	$^{\circ}\!\mathbb{C}$
Lead Soldering Temperature	Tsol	260°€ /5sec	-

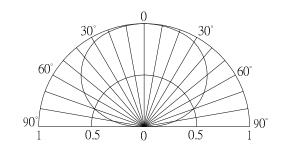
# \*1, Power dissipation and forward current are the value when the module temperature is set lower than the rating by using an adequate heat sink.

## **■Electrical -Optical Characteristics**

Item	Symbol	Condition	Min.	Typ.	Max.	Unit
DC Forward Voltage	$V_F$	I <sub>F</sub> =1000mA	8.7	10	11.4	V
DC Reverse Current	$I_R$	$V_R=15V$	1	1	20	μΑ
Luminous Flux	Фv	I <sub>F</sub> =1000mA	750	850	-	lm
Color Temperature	CCT	I <sub>F</sub> =1000mA	-	6500	-	K
Chromaticity	X	I <sub>F</sub> =1000mA	-	0.31	-	
Coordinates*	у	I <sub>F</sub> =1000mA	-	0.34	-	
50% Power Angle	2θ1/2	I <sub>F</sub> =1000mA	-	140	-	deg

Note: Don't drive at rated current more than 5s without heat sink for High Power series.

## Directivity











<sup>\*2,</sup> Pulse width Max.10ms Duty ratio max 1/10

<sup>\*</sup> Tolerance of chromaticity coordinates is  $\pm 10\%$ , \* Tolerance of Luminous Flux is ±20%



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#### ■Heat design

The following pictures show some measurements of mounted 5W Led on the heat sink for each board A and B (See Fig 1) with using thermograph to make an observation about heat distribution. Each boards is tested at various current conditions.

As a result, LED needs larger heat sink as much as possible to reduce its own case temperature.

Fig. 1 Configuration pattern examples for board assembly

Board	LED power	Material	Surface area (mm²) Min.
A	5W	Al	10,300
В	10W	Al	20,600
С	25W	Al	51,500
D	50W	Al	103,000
Е	100W	Al	206,000
F	200W	Al	412,000
G	300W	Al	618,000

Above tested LED device is attached with adhesive sheet to the heatsink.

For reference's sake, Tj absolute maximum rating is defined at 115°C as a prerequisite on design process of 5W LED.

